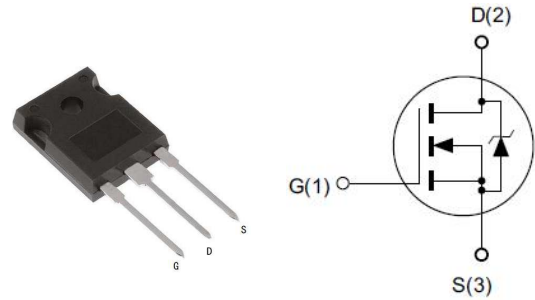


Features

- ◆ 650V, 80A, $R_{DS(ON)}(Typ.) = 34m\Omega @ V_{GS} = 10V$
- ◆ Advanced Super Junction Technology
- ◆ Easy To Control Gate Switching
- ◆ 100% Avalanche Tested



Application

- ◆ For Soft Switching Boost PFC switch,
- ◆ HB or AHB or LLC half bridge and full bridge topologies
- ◆ Phase-shift-bridge (ZVS), LLC Application-Server Power
- ◆ Telecom Power, EV Charging, Solar inverter

Absolute Maximum Ratings $T_c = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Unit
V_{DS}	Drain-Source Voltage ^a	650	V
V_{GS}	Gate-Source Voltage	± 30	
I_D	Drain Current-Continuous, $T_c = 25^\circ\text{C}$	80	A
I_{DM}	Drain Current-Pulsed ^b	240	
P_D	Maximum Power Dissipation @ $T_J = 25^\circ\text{C}$	500	W
dv/dt	Peak Diode Recovery dv/dt ^c	50	V/ns
E_{AS}	Single Pulsed Avalanche Energy ^d	2880	mJ
T_J, T_{STG}	Operating and Store Temperature Range	150, -55 to 150	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case	0.25	$^\circ\text{C/W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	62	

Electrical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

■ Off Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu A$	650	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 650V, V_{GS} = 0V$	-	-	5	μA
I_{GSS}	Forward Gate Body Leakage Current	$V_{DS} = 0V, V_{GS} = \pm 30V$	-	-	± 100	nA

■ On Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	3.0	-	5.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance ^c	$V_{GS} = 10V, I_D = 28A$	-	34	38	mΩ

■ Dynamic Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
R_G	Gate Resistance	$f = 1.0MHz$	-	1.2	-	Ω
C_{iss}	Input Capacitance	$V_{DS} = 400V,$ $V_{GS} = 0V,$ $f = 10kHz$	-	6033	-	pF
C_{oss}	Output Capacitance		-	169	-	
C_{rss}	Reverse Transfer Capacitance		-	12.1	-	

■ On Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 400V,$ $V_{GS} = 13V,$ $I_D = 44.2A,$ $R_G = 1.8\Omega$	-	67.6	-	ns
t_r	Turn-On Rise Time		-	29.8	-	
$t_{d(off)}$	Turn-Off Delay Time		-	30	-	
t_f	Turn-Off Fall Time		-	325.4	-	
Q_g	Total Gate Charge	$V_{DD} = 480V,$ $V_{GS} = 10V,$ $I_D = 44.2A$	-	158.2	-	nC
Q_{gs}	Gate-Source Charge		-	45	-	
Q_{gd}	Gate-Drain Charge		-	61	-	

■ Drain-Source Diode Characteristics

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Unit
V_{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0V, I_F = 1A$	-	0.61	-	V
T_{rr}	Body Diode Reverse Recovery Time	$V_R = 400V, I_F = 44.2A$ $di_F/dt = 100A/\mu s$	-	173.5	-	ns
Q_{rr}	Body Diode Reverse Recovery Charge	$V_R = 400V, I_F = 44.2A$ $di/dt = 100A/\mu s$	-	1.19	-	μC
I_{rrm}	Peak reverse recovery current	$V_R = 400V, I_F = 44.2A$ $di/dt = 100A/\mu s$	-	12.7	-	A

Notes:

- $T_J = +25\text{ }^{\circ}C$ to $+150\text{ }^{\circ}C$
- Repetitive rating; pulse width limited by maximum junction temperature.
- Pulse width $\leq 300\mu s$; duty cycle $\leq 2\%$
- $L = 10mH, V_{DD} = 100V, I_{AS} = 24A, R_G = 25\Omega$ Starting $T_J = 25\text{ }^{\circ}C$.

■ Characteristic Curve

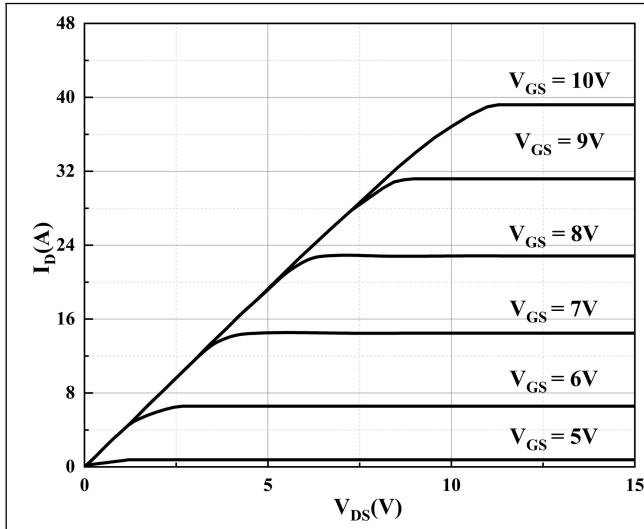


Figure 1. Typical Output Characteristics

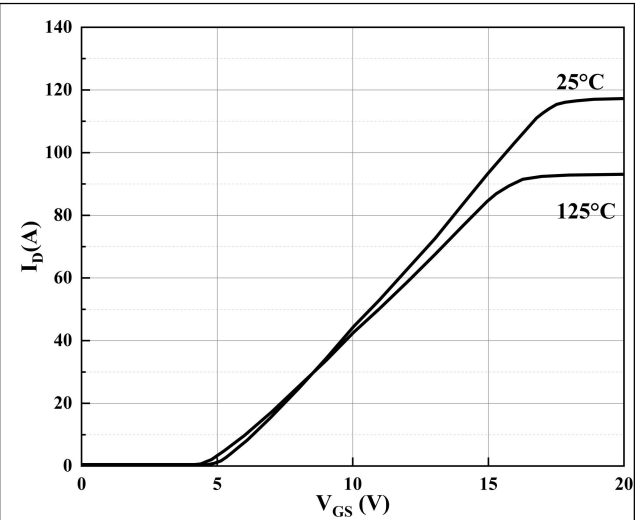


Figure 2. Typical Transfer Characteristics

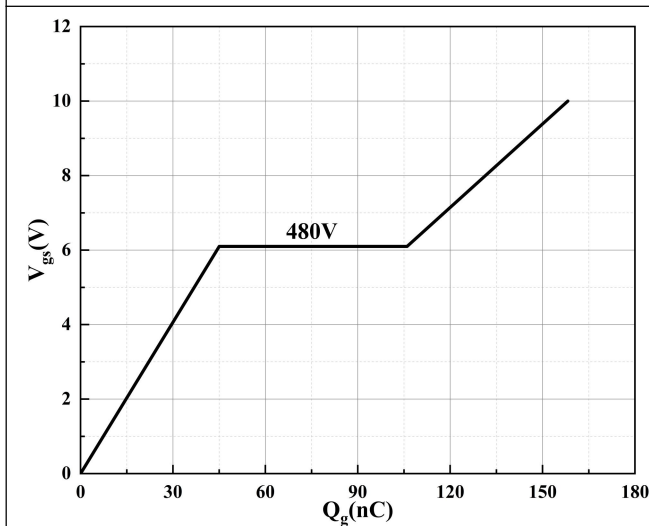


Figure 3. Typical Gate Charge

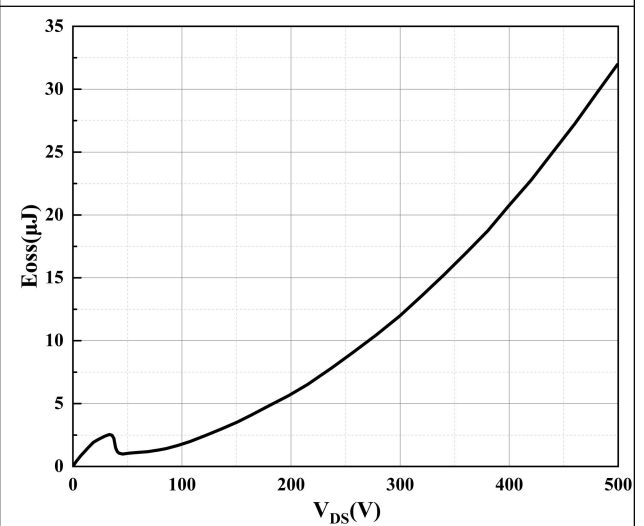


Figure 4. Typical C_{OSS} Stored Energy

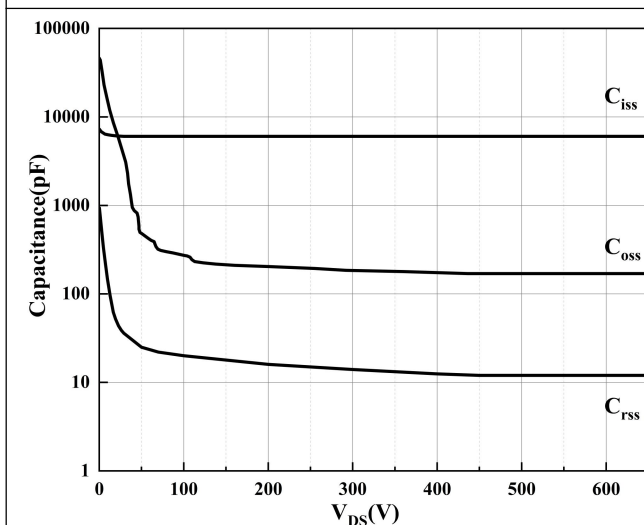


Figure 5. Typical Capacitance

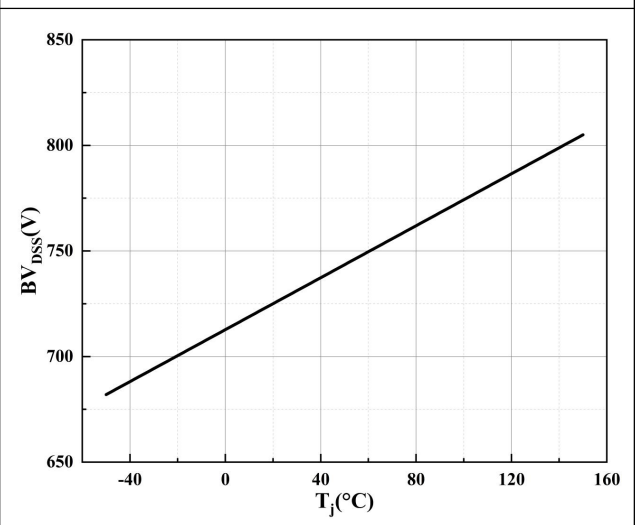


Figure 6. Drain-source Breakdown Voltage

■ Characteristic Curve

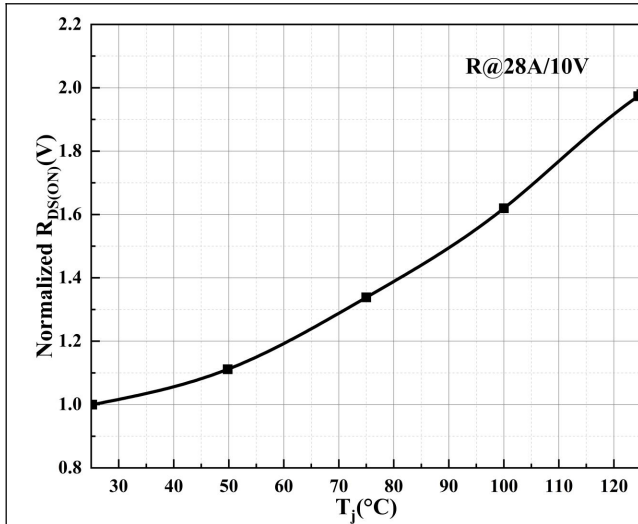


Figure 7. Typical On-Resistance vs Junction Temperature

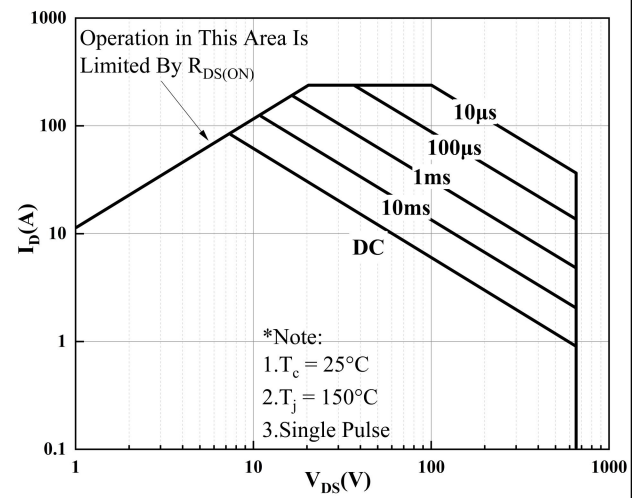
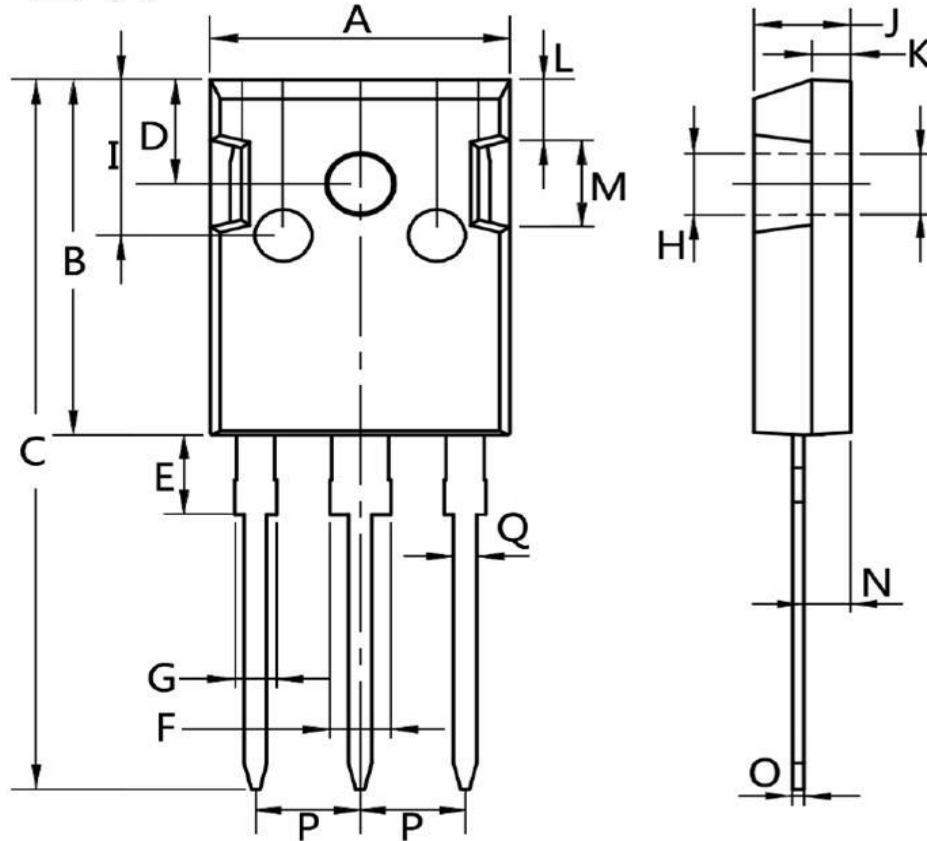


Figure 8. Safe Operating Area

■ Package Information

TO-247



Dim.	Min.	Max.
A	15.0	16.0
B	20.0	21.0
C	40.0	42.0
D	5.5	6.5
E	4.0	5.5
F	2.5	3.5
G	1.75	2.5
H	3.0	4.0
I	8.0	10.0
J	4.9	5.1
K	1.9	2.1
L	3.0	4.0
M	4.75	5.25
N	2.0	3.0
O	0.55	0.65
P	Typ 5.4	
Q	1.2	1.3
All Dimensions in millimeter		